## Bienvenue sur O-MORT

O-Lead Leading s'efforce d'être votre partenaire de solution unique dans la chaîne d'approvisionnement EMS, y compris la conception PCB, la fabrication de circuits imprimé et l'assemblage PCB (PCBA) .Nous fournissons une partie de la technologie PCB la plus avancée, notamment des PCB HDI, des PCB multicouches, des PCBs flexibles rigides Nous pouvons supporter du prototype de virage rapide à la production moyenne et de masse.

En général, nos clients mondiaux sont très impressionnés par nos services: une réponse rapide, des prix compétitifs et un engagement de la qualité.LI PRODUIRE Un service technique plus précieux et une solution globale est la voie à suivre.

En ce qui concerne l'avenir, O-leader se concentrera sur l'innovation et le développement de la technologie de fabrication de l'électronique comme toujours et rendent les efforts persistants sur le service unique de PCB & PCBA afin de fournir des services de première classe et de créer plus de valeur pour nos clients.

Veuillez cliquer sur celles-ci pour plus d'informations: Fabricant de la PCB

Lieu d'origine	Guang Dong, Chine (continentale)	Marque	O-leader
Matériel de base	FR-4 ,, Aluminium, Rogers, Cuivre lourd, etc.	Épaisseur de cuivre	0.5oz-5oz
Min. Taille du trou	0.2mm	Min. Largeur de ligne	0.2mm
Finition de surface	Immersion Gold / Tin / Argent, OSPR, HASL sans plomb	Épaisseur du tableau	0,1-5mm
applicable à	LED, téléphone portable, climatiseurs, machines à laver	personnage	Contrôle industriel PCB
certificats	ISO9001, UL, ROHS, SGS	Q / CTN	exigence du client
Lester	0.01kg -5kg	Moq	10pcs
Couleur	bleu, rouge, vert, black.yellow	Min. Interligne	0.2mm
Numéro de modèle	Fabricant de PCBA de l'Assemblée PCB	le prix	0,1 \$ à 10 \$
Type desigh	exigence du client	Taille	0,01m3-10m3













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### Factory PCB



Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

### Factory SMT













## Certifications







Test Report

O-LEADING SUPPLY CHAIN (HK) CO., LIMITED

No. SZXEC1900530401

1313,FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

Date: 30 Mar 2019 Page 1 of 6

Test Report No. SZXEC1900530401 Date: 30 Mar 2019 Page 2 of 6

Test Results :

Test Part Description :

 Specimen No.
 SGS Sample ID
 Description

 SN1
 SZX19-005304.001
 Green\*PCB\*\*

(1) 1 mg/kg = 1 ppm = 0.0001% (2) MDL = Method Detection Limit

(3) ND = Not Detected ( < MDL )

(4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC682321-5:2013, IEC62321-7:2:2017, IEC 62321-6:2015 and IEC62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Test Item(s)	Limit	Unit	MDL	001
Cadmium (Cd)	100	mg/kg	2	ND
Lead (Pb)	1,000	mg/kg	2	8
Mercury (Hg)	1,000	mg/kg	2	ND
Hexavalent Chromium (Cr(VI))	1,000	mg/kg	8	ND
Sum of PBBs	1.000	mg/kg		ND
Monobromobiphenyl		mg/kg	5	ND
Dibromobiphenyl	12	mg/kg	5	ND
Tribromobiphenyl	15	mg/kg	5	ND
Tetrabromobiphenyl		mg/kg	5	ND
Pentabromobiphenyl		mg/kg	5	ND
Hexabromobiphenyl		mg/kg	5	ND
Heptabromobiphenyl		mg/kg	5	ND
Octabromobiphenyl		mg/kg	5	ND
Nonabromobiphenyl	6	mg/kg	5	ND
Decabromobiphenyl		mg/kg	5	ND
Sum of PBDEs	1,000	mg/kg		ND
Monobromodiphenyl ether		mg/kg	5	ND
Dibromodiphenyl ether	12	mg/kg	5	ND
Tribromodiphenyl ether	2	mg/kg	5	ND
Tetrabromodiphenyl ether	-	mg/kg	5	ND
Pentabromodiphenyl ether		mg/kg	5	ND



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- Remark (14.0 post-times-days-scene)
(2586g to 4.1 post-times-form) (14.0 post-times-for

Member of the SGS Group (SGS SA)

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. : RP19-005089 - SZ Date of Sample Received : 22 Mar 2019

22 Mar 2019 - 30 Mar 2019 Testing Period :

Test Requested : Selected test(s) as requested by client. Test Method Please refer to next page(s).

Test Results : Please refer to next page(s).

Conclusion:

Based on the performed tests on submitted sample(s), the results of Lead. Mercury, Cadmium, Hexavalent chiromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBBcs) and Phthalates such as Bis(2-ethylbexyl) phthalate (DBFP). Bibutyl phthalate (DBFP). Tolbutyl phthalate (DBFP), and Diisobutyl phthalate (DBFP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/85/EU.

Signed for and on behalf of SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

lina

Tina Fan Approved Signatory



Max

Max

### UL Product iQ™



## ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

### Wiring, Printed - Component

See General Information for Wiring, Printed - Component

**Cond Width** 

#### O-LEADING SUPPLY CHAIN (HK) CO LTD

E490354

ROOM 1205, 12/F TAI SANG BANK BLDG 130-132 DES VOEUS ROAD CENTRAL, HONG KONG

		Min	Cond	SS/	Area	Solo	der	Oper		Meets	c
	Min	Edge	Thk	DS/	Diam	Lim	its	Temp	Flame	<b>UL796</b>	T
Type	mm(in)	mm(in)	mic(mil)	DSO	mm(in)	c	sec	c	Class	DSR	1
Multilayer (m	Multilayer (mass laminate) printed wiring boards.										
O-LEADING- 401	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	3	570
O-LEADING- 407	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	-
Multilayer pri	nted wiring bo	ards.	<del></del>						3		
O-LEADING- 408	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
Single layer p	rinted wiring b	oards.							3 77	7.57	
O-LEADING- 002	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
O-LEADING- 003	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	<b>A</b>	-
O-LEADING- 033	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	*
O-LEADING- 205	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING- 206	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING- D01	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
O-LEADING- S01	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

#### WIRING, PRINTED - COMPONENT | UL Product iQ

O-LEADING- S02	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	НВ	<b>A</b>	*
O-LEADING- S03	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All	*

 $<sup>\</sup>mbox{\ensuremath{\star}}$  - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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# Emballage et livraison

# **Shipping service**











	Quick Turn Lead Time					
Layer Count:	Lead Tim	Special Requirement				
1L/2L	2-3days	24 Hours,48 Hours				
4L	3-4days	48 Hours				
6L	4-5days	72 Hours				
8L	5-6days	NA				
10L	6-7days	NA				
12L	7-8days	NA				
14L	8-9days	NA				

	Standard Lead Time					
Layer Count:	Sample Lead Time	Volume order lead time				
2L	4 days	10 days				
4L	5 days	11 days				
6L	6 days	12 days				
8L	8 days	14 days				
10L	10 days	16 days				
12L	12 days	18 days				
14L	14 days	20 days				
16-32L	18 days	24 days				

# Capacité du processus

### Capacités de production de PCB

Compte de couche: 1Layer-32Layer Épaisseur de cuivre finie: 1 / 3oz-12oz

Largeur de ligne min / espacement interne: 3.0mil / 3.0mil Largeur de ligne min / espacement externe: 4.0mil / 4.0mil

Ratio de format max: 10: 1

Épaisseur du tableau: 0.2mm-5,0mm

Max panneau taille (pouces): 635 \* 1500mm

Taille du trou foré minimum: 4mil Tolérance du trou porté: +/- 3mil Biind / Vias enterré (types AII): oui

Via remplissage (conducteur, non conducteur): oui

Matériau de base: FR-4, FR-4HIGHT TG.HALOGEN MATERIAU GRATUIT, ROGERS, BASE

D'ALUMINIUM, Polyimide,

Cuivre lourd

Finitions superficielles: HASL, OSP, ENIG, HAL-LF, LMMERSION Silver, Tin de Immersion, doigts d'or, encre

de carbone

## Capacités de production SMT

Matériel PCB: FR-4, CEM-1, CEM-3, tableau à base d'aluminium

Max PCB Taille: 510x460mm Min PCB Taille: 50x50mm Épaisseur PCB: 0.5mm-4,5mm Épaisseur du tableau: 0.5-4mm Min Composants Taille: 0201

Composant de taille standard de la puce: 0603 et plus grand

Composant Max Hauteur: 15mm Min Pache de plomb: 0.3mm MIN BGA BALL PITCH: 0.4mm

Précision de placement: +/- 0.03mm